TOSHIBA High Efficiency Diode Stack (HED) Silicon Epitaxial Type

U20DL2C53A

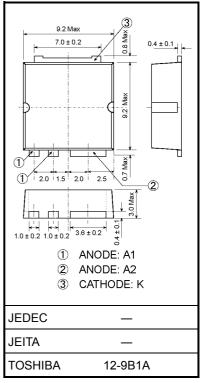
Switching Mode Power Supply Application Converter&Chopper Application

- Repetitive peak reverse voltage: VRRM = 200 V
- Average output recified current: IO = 20 A
- Ultra fast reverse-recovery time: $t_{rr} = 35 \text{ ns (max)}$
- Low switching losses and output noise.
- Power surface mount device for thin flat package. <u>"TFP"</u> (Toshiba package name)

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Repetitive peak reverse voltage	V_{RRM}	200	V	
Average output recified current	IO	20	Α	
Peak one cycle surge forward current	leo.	100 (50 Hz)	А	
(non-repetitive, sine wave)	IFSM	110 (60 Hz)		
Junction temperature	Tj	-40 to 150	°C	
Storage temperature range	T _{stg}	-40 to 150	°C	

Unit: mm



Weight: 0.74 g (typ.)

Polarity



*: Common Terminal

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak forward voltage	V_{FM}	I _{FM} = 10 A	_	_	0.98	V
Repetitive peak reverse current	I _{RRM}	V _{RRM} = 200 V			50	μΑ
Reverse recovery time	t _{rr}	$I_F = 2 \text{ A}, \text{ di/dt} = -50 \text{ A/}\mu\text{s}$	_	_	35	ns
Thermal resistance	R _{th (j-c)}	DC Total, Junction to Case	_	_	1.5	°C/W

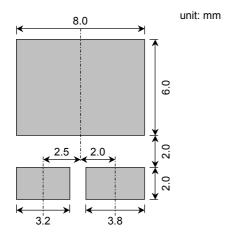
Note: V_{FM} , I_{RRM} , t_{rr} : A value of one cell.

Marking

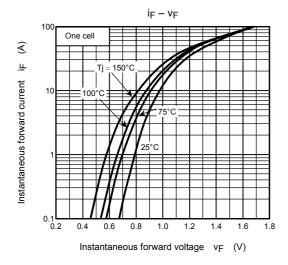


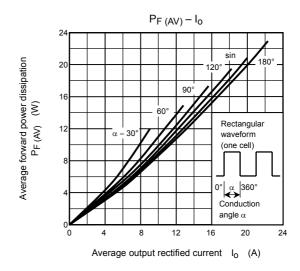
% 1	MARK	20DL2C	TYPE	U20DL2C53A			
※ 2	Α						
※ 3	Lot Number						

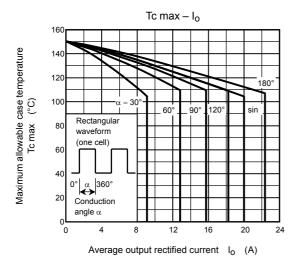
Standard Soldering Pad

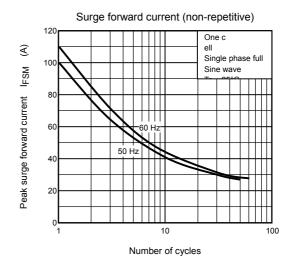


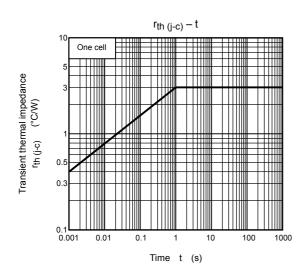
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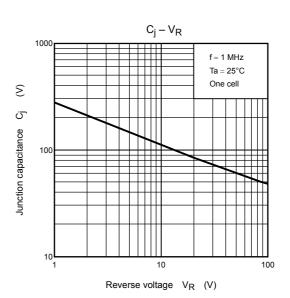












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